

General description

The ESD5B5.0C is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time , make these parts ideal for ESD protection on designs where board space is at a premium

Features and benefits

- Reverse stand-off voltage: 5V Max
- Low leakage current: nA Level
- Low Clamping Voltage: $V_C < 10\text{ V}$ @ $I_{PP} = 30\text{ A}$
- Response time is typically $< 1\text{ ns}$
- ESD Protection: 30kV(air)/ 30kV(contact) (IEC61000-4-2)
- RoHS compliant



SOD523

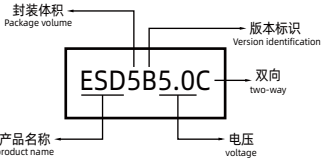
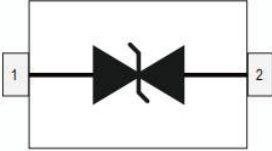
Application information

- Cell Phone Handsets and Accessories
- Microprocessor based equipment
- Personal Digital Assistants (PDA's)
- Notebooks,Desktops,and Servers

Ordering information

Device	Package	Reel Size	Qty(PCS)
ESD5B5.0C	SOD523	7 Inch	3000

Ordering information

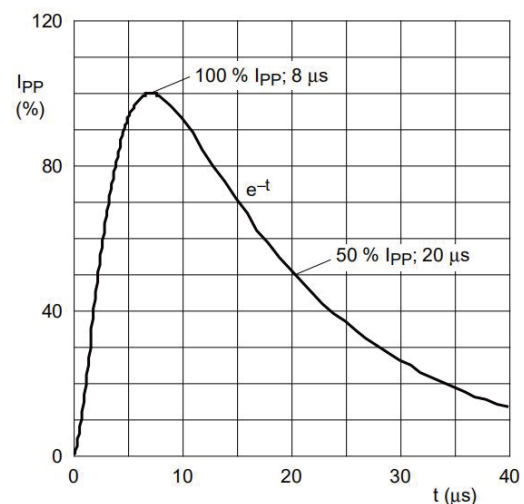
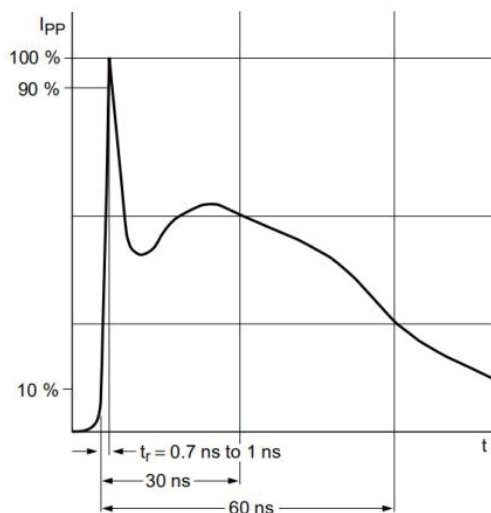
Marking	Naming rule	Graphic symbol
CC		

Maximum Ratings ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power ($t_p = 8/20\mu\text{s}$)	P_{PPM}	300	W
Peak Pulse Current($t_p = 8/20\mu\text{s}$)	I_{PPM}	30	A
Maximum lead temperature for soldering during 10s	T_L	260	$^{\circ}\text{C}$
Storage Temperature Range	T_{stg}	-55 to +150	$^{\circ}\text{C}$
Operating Temperature Range	T_{OP}	-40 to +125	$^{\circ}\text{C}$
Maximum junction temperature	T_j	150	$^{\circ}\text{C}$
ESD voltage IEC 61000-4-2 (air discharge)	V_{ESD}	30	kV
ESD voltage IEC 61000-4-2 (contact discharge)	V_{ESD}	30	kV

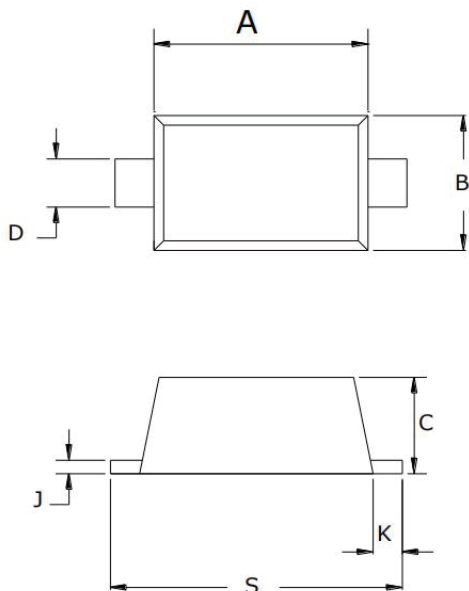
Electrical Characteristics ($T_A = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Condition
Reverse Working Voltage	V_{RWM}	--	--	5.0	V	
Breakdown Voltage	V_{BR}	5.6	--	--	V	$I_T = 1\text{ mA}$
Leakage Current I_{Leak}	I_R	--	--	100	nA	$V_{RWM} = 5\text{ V}$
Clamping Voltage	V_C	--	--	10.0	V	$I_{PP} = 30\text{ A}, t_p = 8/20\mu\text{s}$
Junction Capacitance	C_J	--	60	80	pF	$V_R = 0\text{ V}, f = 1\text{ MHz}$



Package Outline Dimensions

SOD523



SYMBOL	MILLIMETERS	
	MIN	MAX
A	1.10	1.30
B	0.70	0.90
C	0.50	0.70
D	0.25	0.35
J	0.07	0.20
K	0.15	0.25
S	1.50	1.70

Soldering Footprint (mm)

